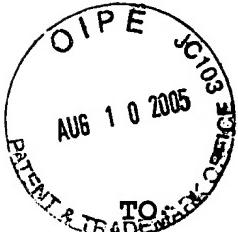


28 B AF



July 13, 2005

Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

FROM: George O. Saile, Reg. No. 19,572
28 Davis Ave.
Poughkeepsie, N.Y. 12603

SUBJECT: Serial #: 09/817,473
File Date: 03/26/2001
Inventor: XU ET AL.
Examiner: NGUYEN, THANH T.
Art Unit: 2813
Title: GAP FILLING PROCESS IN INTEGRATED
CIRCUITS USING LOW DIELECTRIC CONSTANT
MATERIALS
Customer Number: 28112

RESPONSE TO OFFICE ACTION

This is in response to the Final Office Action dated June 08, 2005. Please consider the following in regards to the above referenced application.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on August 8, 2005.

Signature

Date:

8/8/05

Stephen B. Ackerman, Reg. No. 37,761

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Remarks begin on page 5 of this paper.